
2SD1470

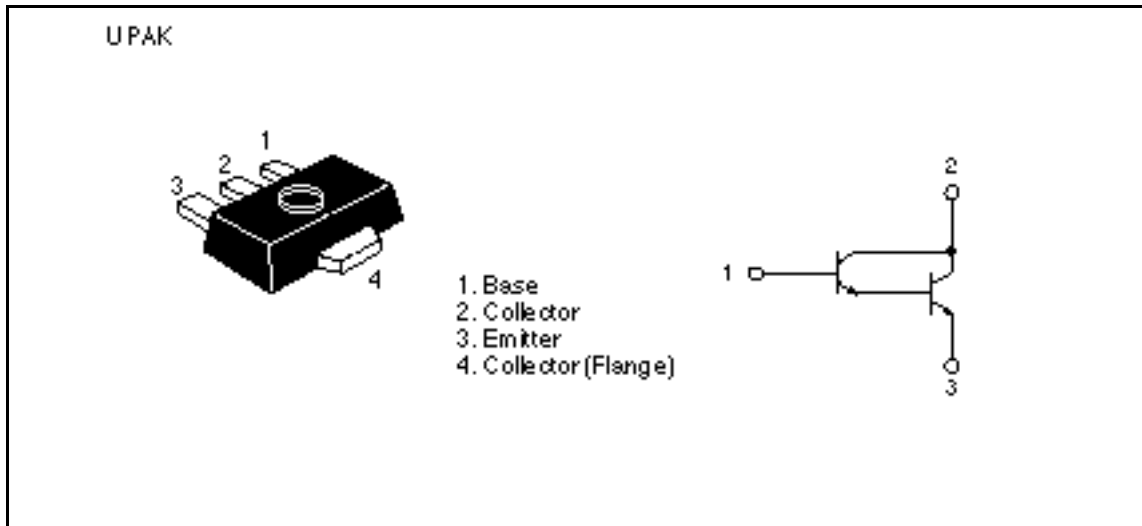
Silicon NPN Epitaxial, Darlington

HITACHI

Application

Low frequency power amplifier

Outline



2SD1470

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	60	V
Collector to emitter voltage	V_{CEO}	60	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I_C	1	A
Collector peak current	$i_{C(\text{peak})}^{*1}$	2	A
Collector power dissipation	P_C^{*2}	1	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Notes: 1. PW 10 ms, Duty cycle 20%

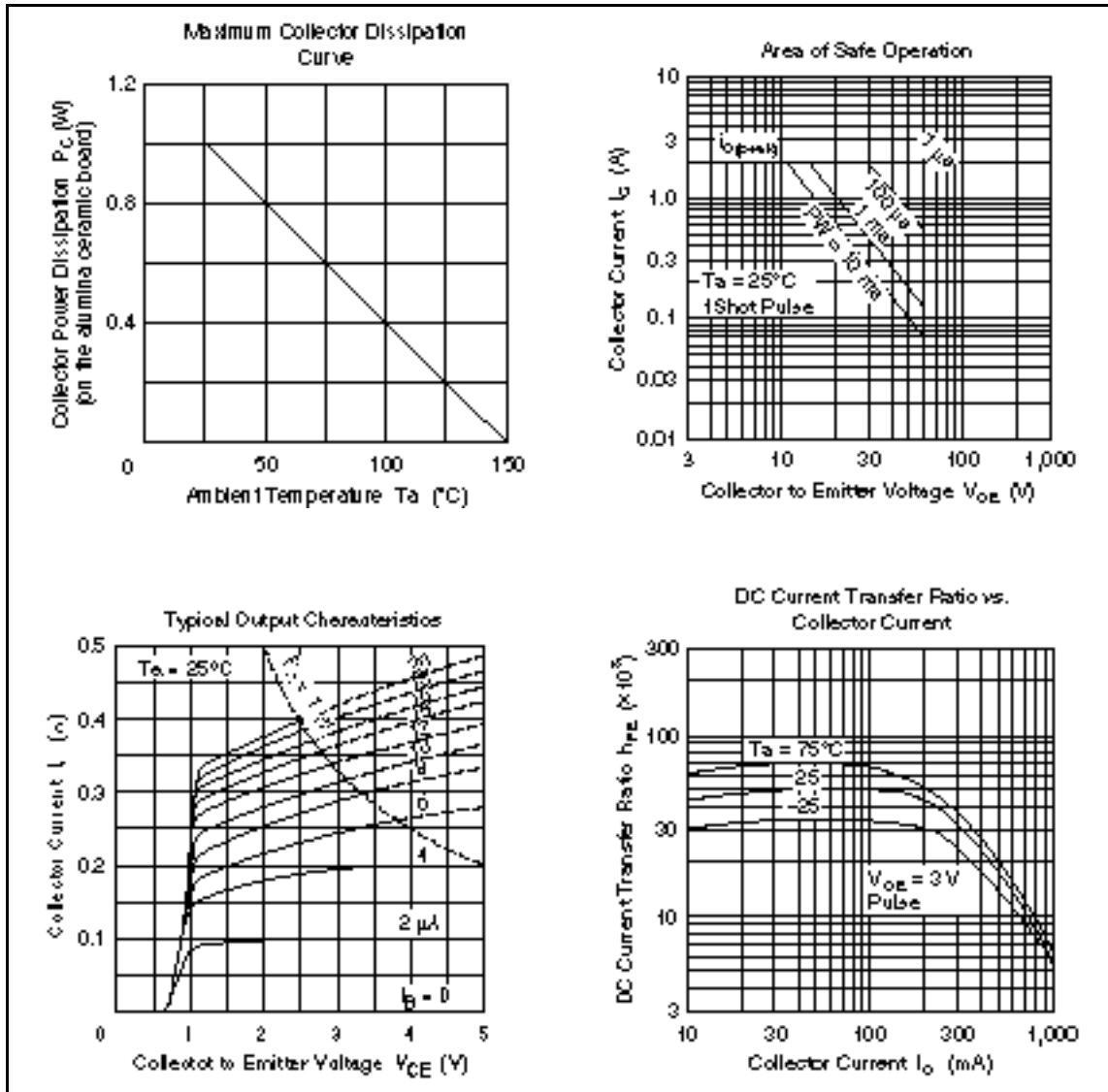
2. Value on the alumina ceramic board (12.5 x 30 x 0.7 mm)

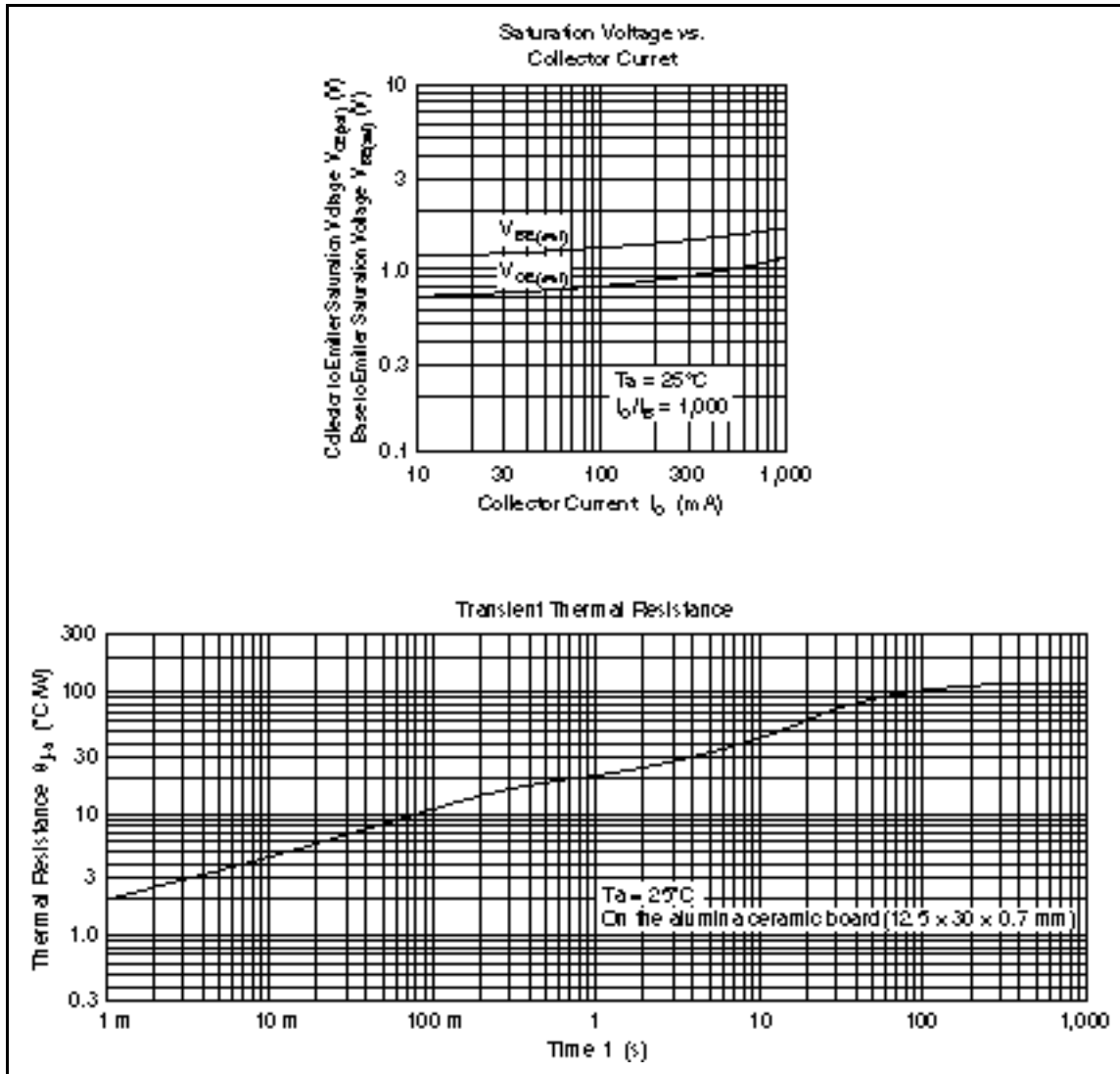
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	60	—	—	V	$I_C = 10 \mu\text{A}$, $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	60	—	—	V	$I_C = 1 \text{ mA}$, $R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	$I_E = 10 \mu\text{A}$, $I_C = 0$
Collector cutoff current	I_{CBO}	—	—	10	μA	$V_{CB} = 60 \text{ V}$, $I_E = 0$
Emitter cutoff current	I_{EBO}	—	—	10	μA	$V_{EB} = 7 \text{ V}$, $I_C = 0$
DC current transfer ratio	h_{FE}	2000	—	100000		$V_{CE} = 3 \text{ V}$, $I_C = 0.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(\text{sat})}$	—	—	1.5	V	$I_C = 500 \text{ mA}$, $I_B = 0.5 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(\text{sat})}$	—	—	2.0	V	$I_C = 500 \text{ mA}$, $I_B = 0.5 \text{ mA}^{*1}$

Notes: 1. Pulse test

2. Marking is "AT".





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